



## Features

- Lead free
- RoHS compliant\*
- Low profile package
- Surface mount
- Very low forward voltage drop

 Model CD1607-B120LF is currently available, but not recommended for new designs. Model CD1607-B140LF is the recommended alternative with a higher  $V_{RRM}$ .

## CD1607-B120 ~ B140L Schottky Barrier Rectifier Chip Diode

### General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package 1607 (Mini-SMA) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 1 A with a choice of repetitive peak reverse voltage of 20 V up to 40 V.

Bourns® Chip Diodes conform to JEDEC standards, easy to handle on standard pick and place equipment and their flat configuration makes roll away much more difficult.

### Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD1607-				Unit
		B120	B120L	B140	B140L	
Forward Voltage (Max.) ( $I_f = 1\text{ A}$ )	$V_F$	0.5	0.38	0.5	0.4	V
Typical Junction Capacitance*	$C_T$	110	100	110	110	pF
Reverse Current (Max.) at Rated $V_R$	$I_R$	0.5	1.0	0.5	1.0	mA

\* Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.

### Absolute Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD1607-				Unit
		B120	B120L	B140	B140L	
Repetitive Peak Reverse Voltage	$V_{RRM}$	20	20	40	40	V
Reverse Voltage	$V_R$	20	20	40	40	V
Maximum RMS Voltage	$V_{RMS}$	14	14	28	28	V
Avg. Forward Current	$I_O$	1				A
Forward Current, Surge Peak (60 Hz, 1 cycle)	$I_{surge}$	30*				A
Typical Thermal Resistance**	$R_{\theta JL}$	20				$^\circ\text{C}/\text{W}$
Storage Temperature	$T_{STG}$	-55 to +150				$^\circ\text{C}$
Junction Temperature	$T_J$	-55 to +125				$^\circ\text{C}$

\*\* Thermal resistance junction to lead.

\* Condition: 8.3 ms single half sine-wave superimposed on rate load (JEDEC method).

# BOURNS®

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[www.bourns.com](http://www.bourns.com)

\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and

RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

### How To Order

**CD 1607 - B 1 20 L LF**

Common Code \_\_\_\_\_  
 Chip Diode \_\_\_\_\_  
 Package \_\_\_\_\_  
 • 1607 = Mini-SMA  
 Model \_\_\_\_\_  
 B = Schottky Barrier Series  
 Average Forward Current ( $I_O$ ) Code \_\_\_\_\_  
 1 = 1 A (Code x 1000 mA = Average Forward Current)  
 Reverse Voltage ( $V_R$ ) Code \_\_\_\_\_  
 20 = 20 V  
 40 = 40 V  
 Forward Voltage Suffix \_\_\_\_\_  
 L = Low Forward Voltage  $V_f$  (CD1607-B120L, CD1607-B140L)  
 Terminations \_\_\_\_\_  
 LF = 100 % Sn (lead free)

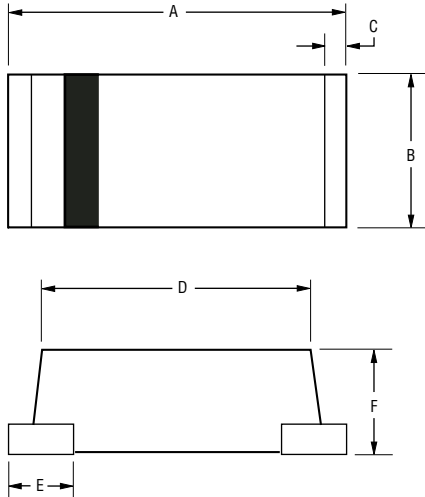
## Applications

- Cellular phones
- PDAs
- Desktop PCs and notebooks
- Digital cameras
- MP3 players

# CD1607-B120 ~ B140L Schottky Barrier Rectifier Chip Diode

**BOURNS®**

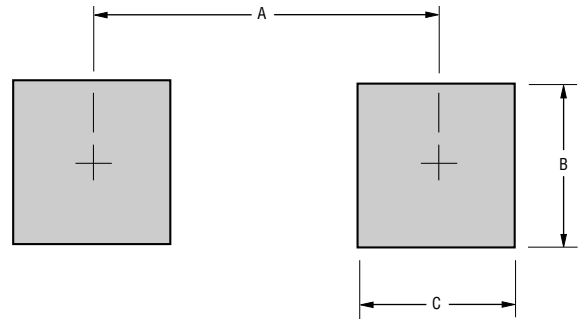
### Product Dimensions



Dimension	Mini-SMA
A	$\frac{3.70 - 4.10}{(0.146 - 0.161)}$
B	$\frac{1.40 - 1.80}{(0.055 - 0.071)}$
C	$\frac{0.30}{(0.012)}$ TYP.
D	$\frac{2.40 - 2.80}{(0.094 - 0.110)}$
E	2 PLCS. $\frac{0.90}{(0.035)}$ TYP.
F	$\frac{1.40 - 1.60}{(0.055 - 0.063)}$

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

### Recommended Pad Layout



Dimension	Mini-SMA
A (Max.)	$\frac{3.50}{(0.138)}$
B (Min.)	$\frac{1.50}{(0.059)}$
C (Min.)	$\frac{1.50}{(0.059)}$

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

### Physical Specifications

Case.....1607 Molded plastic  
 Polarity .....Color band denotes cathode end  
 Terminals.....Solderable per MIL-STD-750, Method 206  
 Weight .....Approximately 0.04 grams

### Typical Part Marking

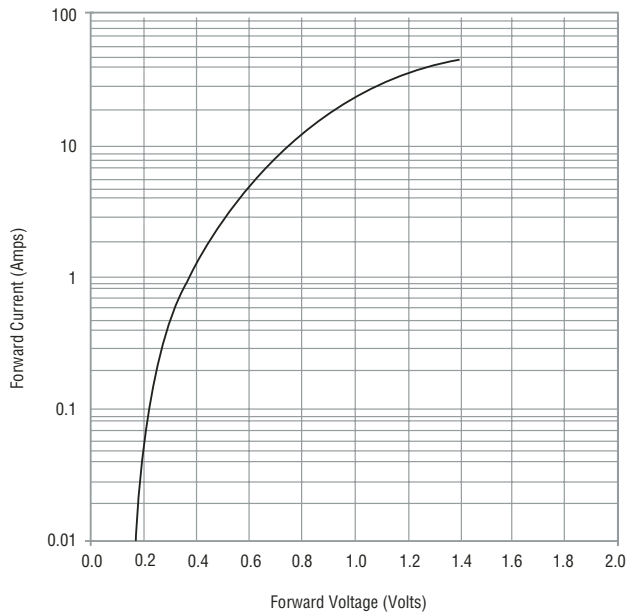
CD1607-B120 .....I2  
 CD1607-B120L .....L2  
 CD1607-B140 .....I4  
 CD1607-B140L .....L4

# CD1607-B120 ~ B140L Schottky Barrier Rectifier Chip Diode

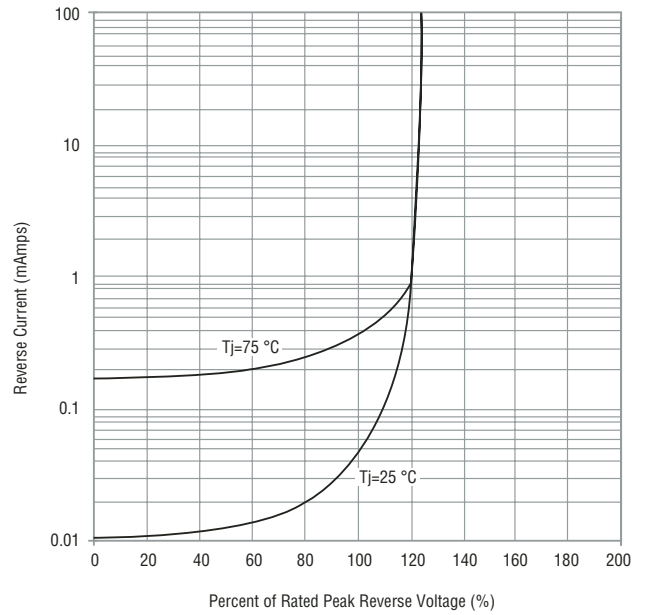


## Rating and Characteristic Curves: CD1607-B120 & CD1607-B140

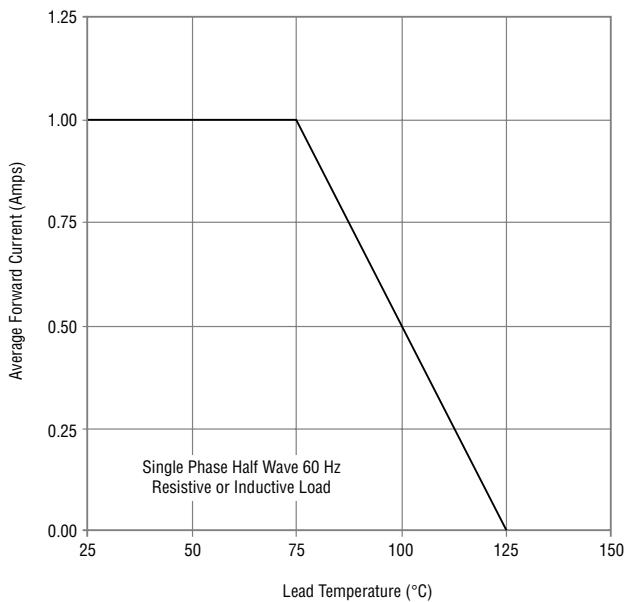
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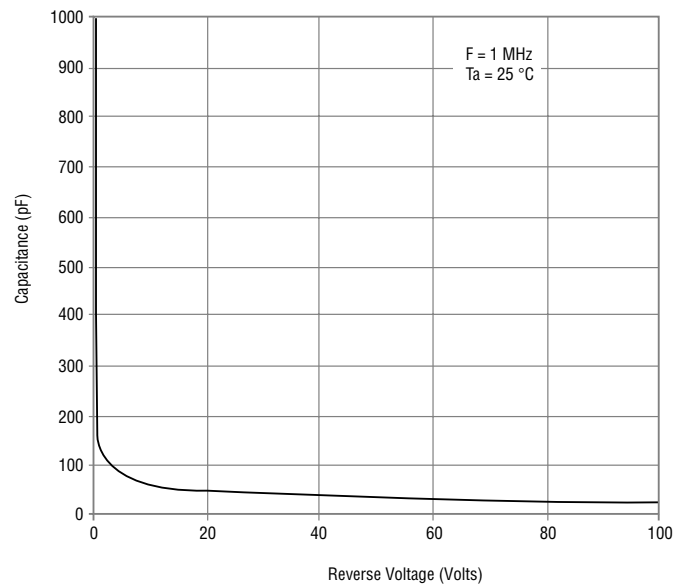
### Reverse Characteristics



### Derating Curve



### Capacitance Between Terminals



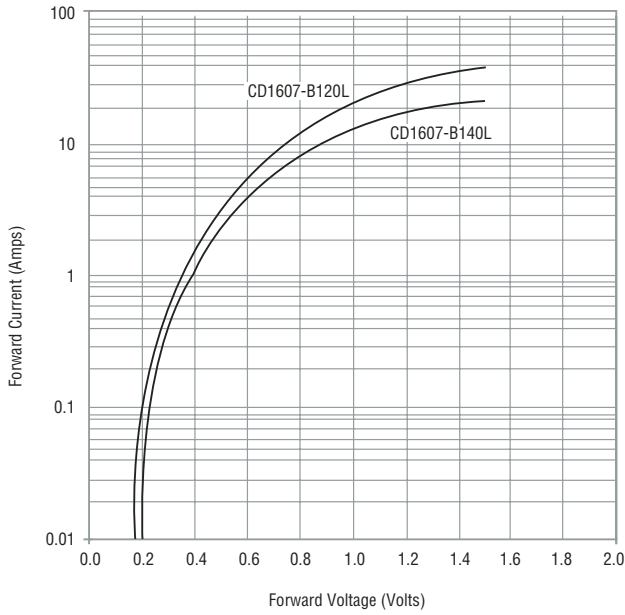
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 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
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# CD1607-B120 ~ B140L Schottky Barrier Rectifier Chip Diode

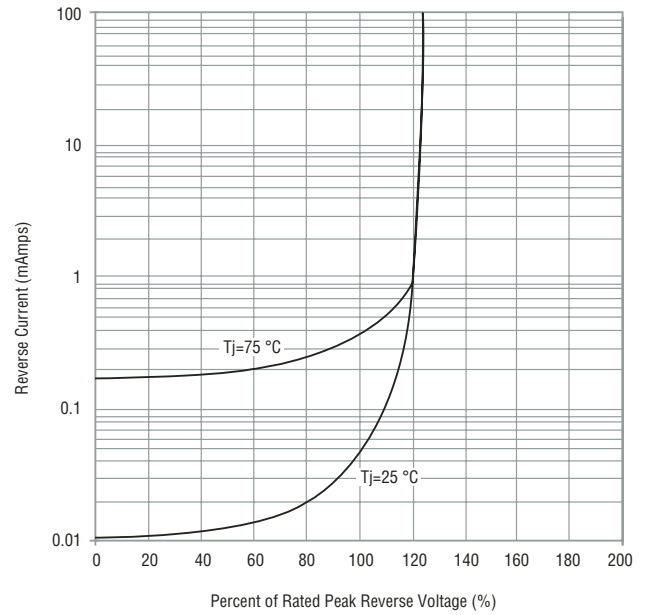


## Rating and Characteristic Curves: CD1607-B120L & CD1607-B140L

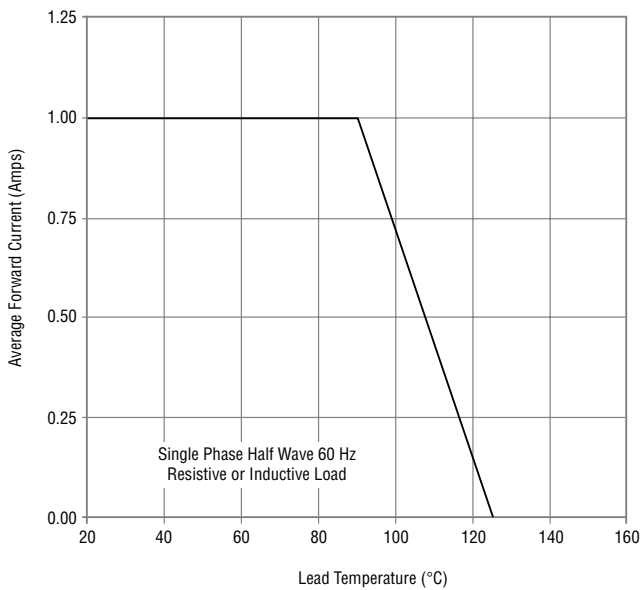
### Forward Characteristics



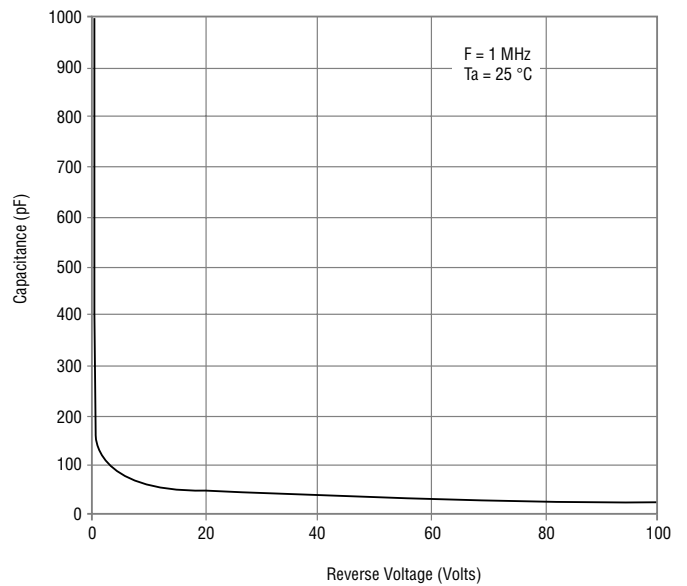
### Reverse Characteristics



### Derating Curve



### Capacitance Between Terminals



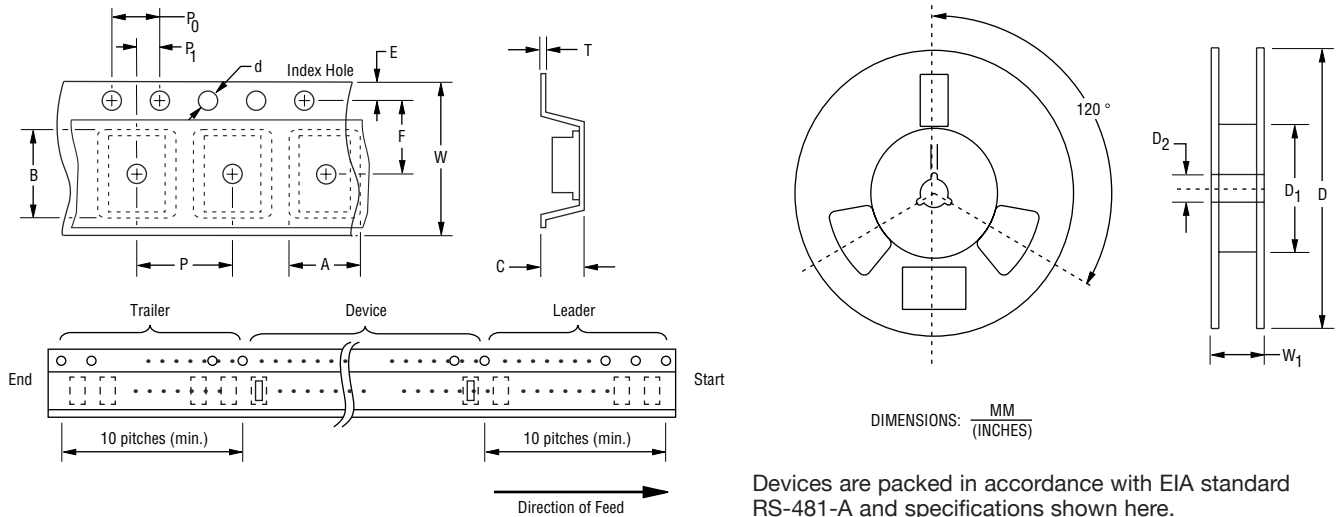
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# CD1607-B120 ~ B140L Schottky Barrier Rectifier Chip Diode

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## Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).



Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	1607
Carrier Width	A	$\frac{1.90 \pm 0.10}{(0.075 - 0.004)}$
Carrier Length	B	$\frac{4.30 \pm 0.10}{(0.169 - 0.004)}$
Carrier Depth	C	$\frac{1.80 \pm 0.10}{(0.071 - 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 - 0.002)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{80.0}{(3.150)}$ MIN.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 - 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 - 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 - 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 - 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 - 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 - 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{13.5}{(0.531)}$ MAX.
Quantity per Reel	--	2,500

REV. 06/14

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